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THYRISTORS
AC16DSMA,AC16FSMA

16 A MOLD ISOLATED TRIAC

DESCRIPTION

The AC16DSMA and AC16FSMA are all diffused mold type triac granted RMS on-state current 16 A, with rated voltages up to 600 V.

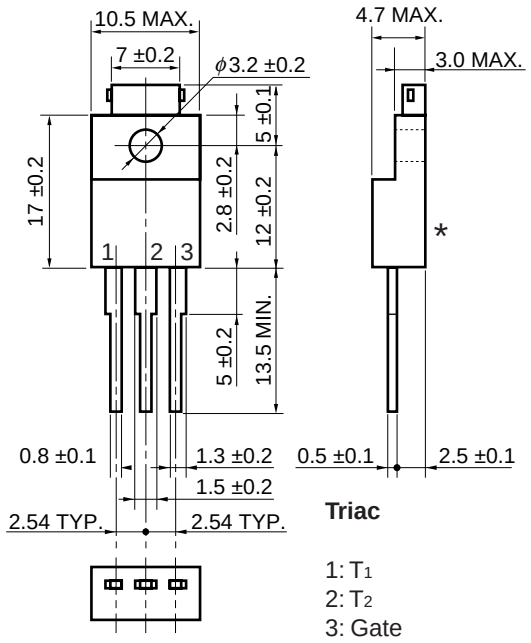
FEATURES

- Isolated plastic package (modified TO-220AB)
- 150 A surge current

APPLICATIONS

- Motor speed control
- Lamp dimmer, temperature controllers
- Various solid state switches, etc.

★ PACKAGE DRAWING (Unit: mm)



Triac

1: T_1
2: T_2
3: Gate

*: T_C test bench-mark

Standard weight: 2 g

★ ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	AC16DSMA	AC16FSMA	Unit	Remarks
Non-repetitive Peak Off-state Voltage	V_{DSM}	500	700	V	–
Repetitive Peak Off-state Voltage	V_{DRM}	400	600	V	–
RMS On-state Current	$I_{T(RMS)}$	16 (T_C = 68°C)		A	Refer to **Figure 11**.
Surge On-state Current	I_{TSM}	150 (50 Hz 1 cycle) 165 (60 Hz 1 cycle)		A	Refer to **Figure 2**.
Fusing Current	$\int i_T^2 dt$	100 (1 ms ≤ t ≤ 10 ms)		A^2s	–
Critical Rate Rise of On-state Current	dI_T/dt	50		A/μs	–
Peak Gate Power Dissipation	P_{GM}	5 (f ≥ 50 Hz, Duty ≤ 10%)		W	Refer to **Figure 3**.
Average Gate Power Dissipation	$P_{G(AV)}$	0.5		W	
Peak Gate Current	I_{GM}	±3 (f ≥ 50 Hz, Duty ≤ 10%)		A	
Junction Temperature	T_j	–40～+125		°C	–
Storage Temperature	T_{stg}	–55～+150		°C	–

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ELECTRICAL CHARACTERISTICS (T_j = 25°C)

Parameter		Symbol	Conditions		MIN.	TYP.	MAX.	Unit	Remarks
Repetitive Peak Off-state Current		I_{DRM}	$V_{DM} = V_{DRM}$	T_j = 25°C	–	–	100	μA	–
				T_j = 125°C	–	–	2	mA	–
On-state Voltage		V_{TM}	I_{TM} = 25 A		–	–	1.4	V	Refer to **Figure 1**.
Gate Trigger Current	Mode I	I_{GT}	V_{DM} = 12 V,	T_2+, G+	–	–	30	mA	Refer to **Figure 4**, **5** and **7**.
	II		R_L = 30 Ω	T_2–, G+	–	–	–		
	III			T_2–, G–	–	–	30		
	IV			T_2+, G–	–	–	30		
Gate Trigger Voltage	Mode I	V_{GT}	V_{DM} = 12 V,	T_2+, G+	–	–	1.5	V	Refer to **Figure 4**, **6** and **8**.
	II		R_L = 30 Ω	T_2–, G+	–	–	–		
	III			T_2–, G–	–	–	1.5		
	IV			T_2+, G–	–	–	1.5		
Gate Non-trigger Voltage		V_{GD}	T_j = 125°C, $V_{DM} = \frac{1}{2} V_{DRM}$		0.3	–	–	V	–
Holding Current		I_H	V_{DM} = 24 V, I_{TM} = 20 A		–	30	–	mA	Refer to **Figure 9**.
Critical Rate Rise of Off-state Voltage		dv/dt	T_j = 125°C, $V_{DM} = \frac{2}{3} V_{DRM}$		–	100	–	V/μs	
Commutating Critical Rate Rise of Off-state Voltage		(dv/dt)c	T_j = 125°C, I_{TM} = 22 A (di_T/dt)c = –8 A/ms, V_D = 400 V		10	–	–	V/μs	–
Thermal Resistance [Note]		$R_{th(j-c)}$	Junction to case AC		–	–	3.3	°C/W	Refer to **Figure 13**.
		$R_{th(j-a)}$	Junction to ambient AC		–	–	60	°C/W	

★ **Note** The thermal resistance at 50 Hz and 60 Hz sine wave current, which is shown on the follow expression.

$$R_{th(j-c)} = \frac{T_{j(max)} - T_C}{P_{T(AV)}}$$

$T_{j(max)}$: Maximum junction temperature

T_C: Case temperature

$P_{T(AV)}$: Average on-dissipation

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TYPICAL CHARACTERISTICS

Figure 1. i_T vs. v_T CHARACTERISTIC

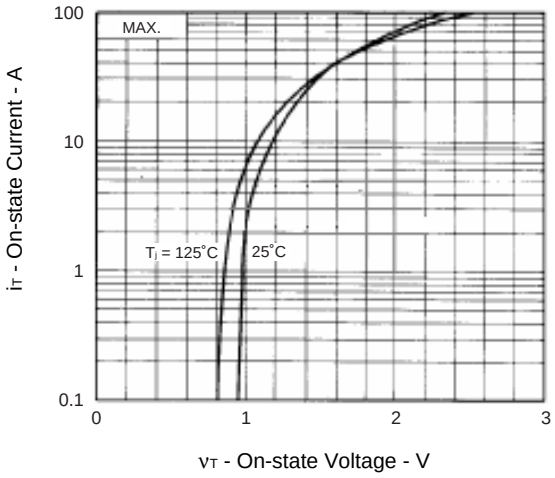

Figure 2. I_{TSM} RATING

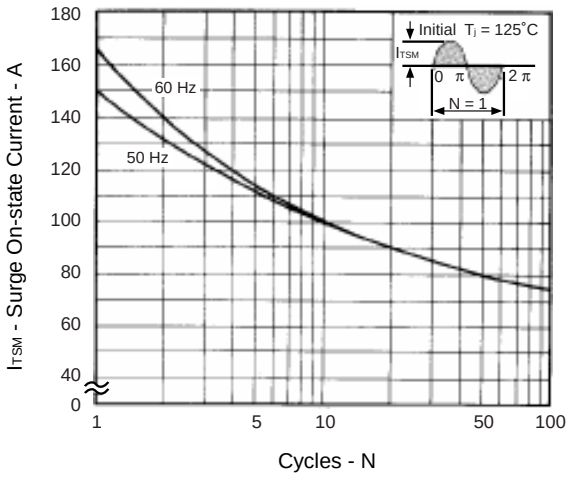

Figure 3. GATE RATING

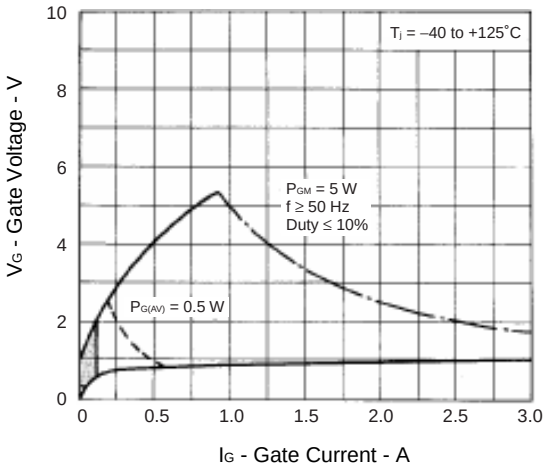

Figure 4. GATE CHARACTERISTIC

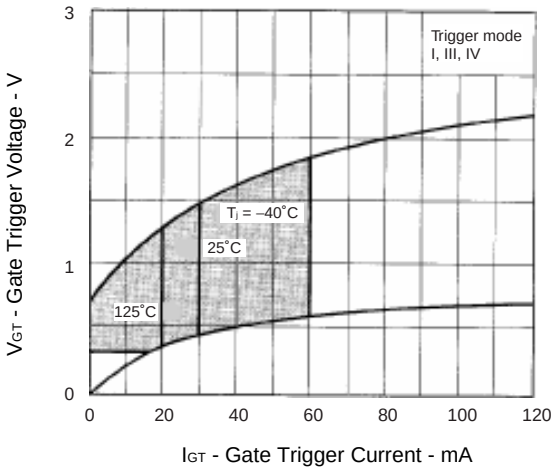

Figure 5. I_{GT} vs. T_A CHARACTERISTIC

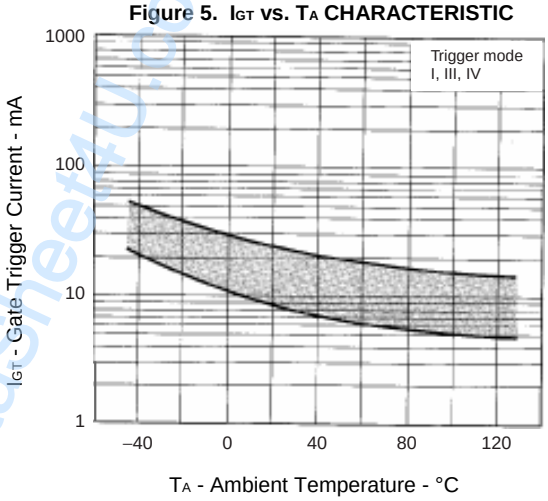

Figure 6. V_{GT} vs. T_A CHARACTERISTIC

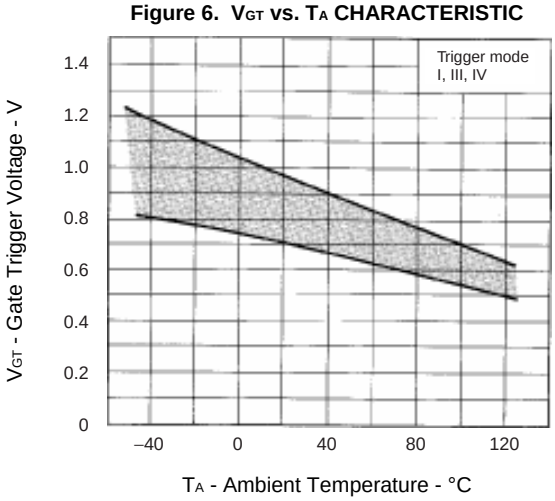

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Figure 7. i_{GT} vs. τ CHARACTERISTIC

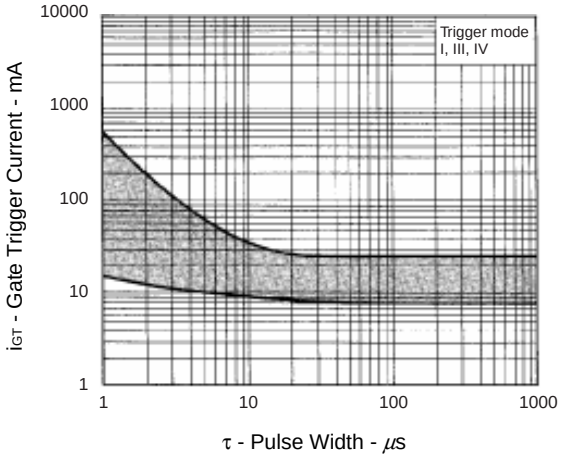

Figure 8. v_{GT} vs. τ CHARACTERISTIC

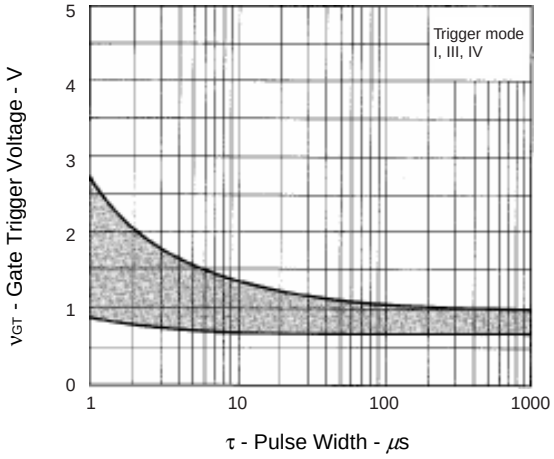

Figure 9. I_H vs. T_A CHARACTERISTIC

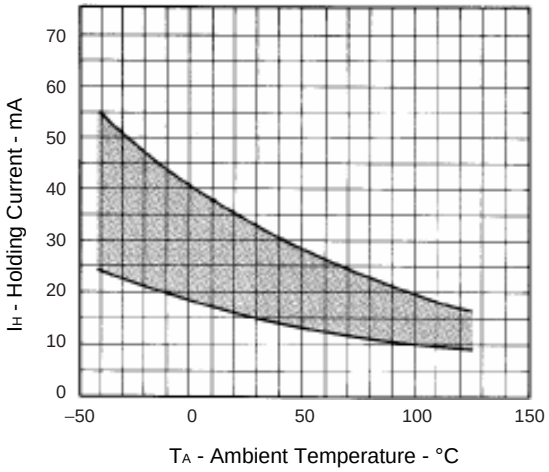

Figure 10. $P_{T(AV)}$ vs. $I_{T(RMS)}$ CHARACTERISTIC

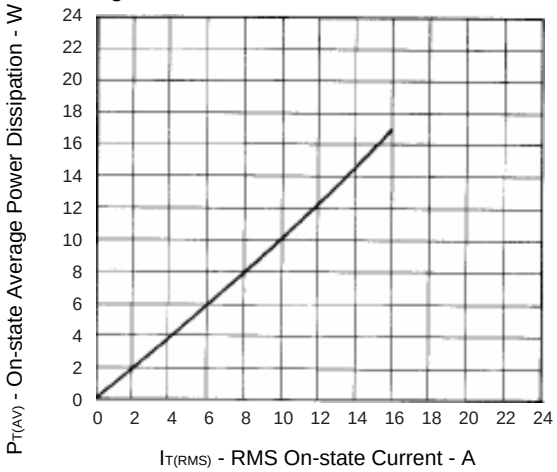

Figure 11. T_C vs. $I_{T(RMS)}$ RATING

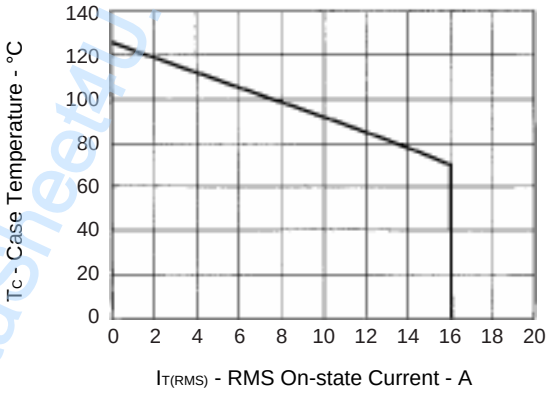

Figure 12. T_A vs. $I_{T(RMS)}$ RATING

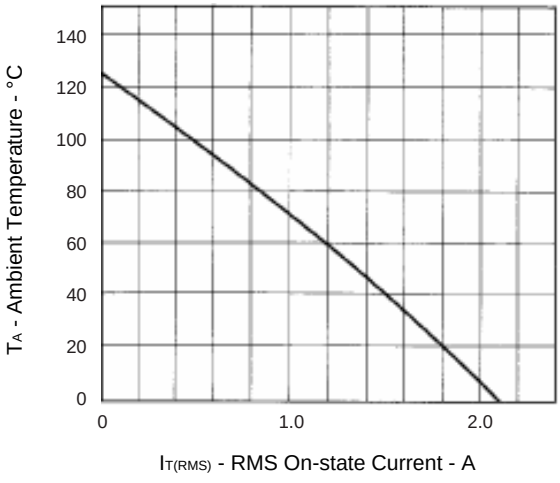

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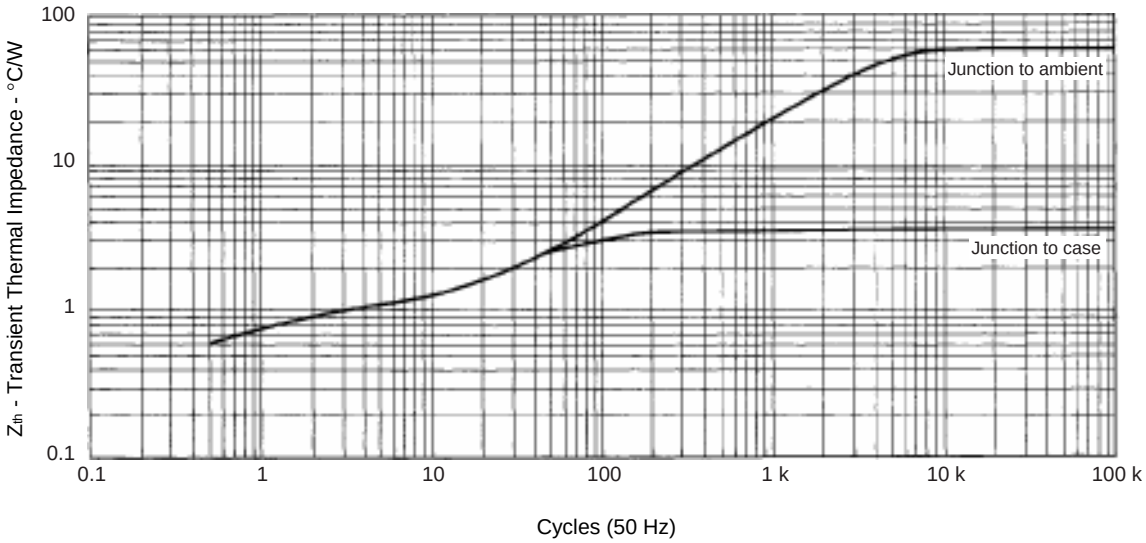
Figure 13. Z_{th} CHARACTERISTIC



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